



Solid State Devices, Inc.

14701 Firestone Blvd * La Mirada, Ca 90638
 Phone: (562) 404-4474 * Fax: (562) 404-1773
 ssdi@ssdi-power.com * www.ssdi-power.com

Designer's Data Sheet

Part Number/Ordering Information ^{1/}

SDR20

Screening ^{2/}

— = Not Screened

TX = TX Level

TXV = TXV

S = S Level

Package Type

— = Axial Leaded

SMS = Surface Mount Square Tab

Voltage/Family

JF = 600V

KF = 800V

MF = 1000V

SDR20JF thru SDR20MF Series

20 AMP
FAST RECOVERY CONTROLLED
AVALANCHE RECTIFIER
600 – 1000 VOLTS, 250 ns typical

FEATURES:

- Fast Reverse Recovery
- PIV to 1000 Volts
- Repetitive High Reverse Energy Rated (> 500 μ J at I_{PK} max = 200 mA)
- Hermetically Sealed
- Low Reverse Leakage Current
- Replaces Larger DO-4 Rectifiers
- Low Thermal Resistance
- Available in Axial & Square Tab Versions
- TX, TXV, and S-Level Screening Available ^{2/}

BENEFITS / APPLICATIONS:

- Unmatched standards of reliability for PRV's up to 1000 V, as well as at lower voltages
- Protection of other circuit components against overvoltage through rigidly specified maximum / minimum avalanche characteristics
- Simplified series operation of rectifiers in high voltage applications – no shunting resistors necessary for Controlled Avalanche Rectifiers; makes possible compact high voltage assemblies
- Can operate in the avalanche breakdown region at high voltages

MAXIMUM RATINGS ^{3/}		SYMBOL	VALUE	UNIT
Peak Repetitive Reverse Voltage and DC Blocking Voltage	SDR20JF	V_{RRM}	600	V
	SDR20KF	V_{RWM}	800	
	SDR20MF	V_R	1000	
Average Rectified Forward Current Resistive load, 60 Hz, sine wave, $T_A = 25^\circ\text{C}$		I_O	20	A
Peak Surge Current 8.3 ms pulse, half sine wave, superimposed on I_O , allow junction to reach equilibrium between pulses, $T_A = 25^\circ\text{C}$		I_{FSM}	190	A
Reverse Power Surge Non-repetitive, ≤ 10 usec, square wave $T_C \leq 125^\circ\text{C}$ Repetitive, ≤ 10 μ sec, square wave $T_C \leq 125^\circ\text{C}$		P_{RSM} P_{RSR}	2.4 0.6	kW
Average DC Reverse Power in Breakdown Region $T_C \leq 125^\circ\text{C}$		$P_{R(AV)}$	4.3	
Operating Temperature		T_J	-65 to +175	$^\circ\text{C}$
Storage Temperature		T_{STG}	-65 to +200	$^\circ\text{C}$
Thermal Resistance Junction to Lead for Axial, $L = .125"$ Junction to End Tab for Surface Mount		$R_{\theta JL}$ $R_{\theta JE}$	6.0 3.0	$^\circ\text{C/W}$

NOTES: ^{1/} For ordering information, price, operating curves, and availability- contact factory.

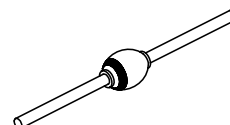
^{2/} Screening based on MIL-PRF-19500. Screening flows available on request.

^{3/} Unless otherwise specified, all electrical characteristics @25 $^\circ\text{C}$.

^{4/} $I_F = 500\text{mA}$, $I_R = 1\text{A}$, $I_{RR} = 250\text{mA}$, $T_A = 25^\circ\text{C}$

Axial Leaded

SMS



NOTE: All specifications are subject to change without notification.
 SCD's for these devices should be reviewed by SSDI prior to release.

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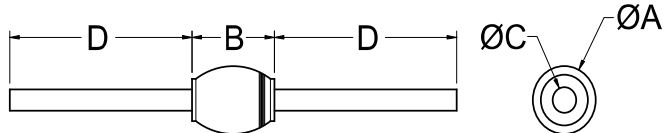
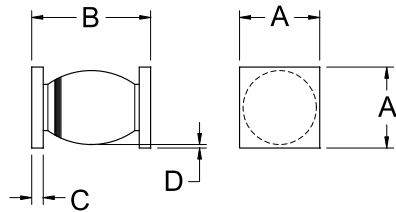
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SDR20JF thru SDR20MF Series

ELECTRICAL CHARACTERISTICS ^{3/}

CHARACTERISTICS		SYMBOL	VALUE			UNIT
			MIN	TYP	MAX	
Instantaneous Forward Voltage Drop (pulsed) $T_A = 25^\circ\text{C}$	$I_F = 3.0 \text{ Adc}$	V_{F1}	--	0.92	1.00	V
	$I_F = 9.0 \text{ Adc}$	V_{F2}	--	1.07	1.15	
	$I_F = 20 \text{ Adc}$	V_{F3}	--	1.22	1.30	
Instantaneous Forward Voltage Drop (pulsed) $T_A = -55^\circ\text{C}$	$I_F = 9.0 \text{ Adc}$	V_{F4}	--	1.18	1.30	V
Reverse Leakage Current Rated V_R , 300 μs pulse minimum	$T_A = +25^\circ\text{C}$	I_{R1}	--	0.30	2.0	μA
	$T_A = +100^\circ\text{C}$	I_{R2}	--	15	40	
	$T_A = +150^\circ\text{C}$	I_{R3}	--	100	150	
Avalanche Breakdown Voltage 5 mA test current at $T_J = 25^\circ\text{C}$	SDR20JF	B_{VR}	650	--	900	V
	SDR20KF		850	--	1100	
	SDR20MF		1050	--	1400	
Junction Capacitance $V_R = 10 \text{ Vdc}$, $f = 1 \text{ MHz}$, $T_A = 25^\circ\text{C}$		C_J	--	50	70	pF
Reverse Recovery Time $I_F = 500 \text{ mA}$, $I_R = 1 \text{ A}$, $I_{RR} = 250 \text{ mA}$, $T_A = 25^\circ\text{C}$		t_{RR}	--	250	350	ns

Package Outlines:

DIMENSIONS (inches)			DIMENSIONS (inches) *		
DIM.	Minimum	Maximum	DIM.	Minimum	Maximum
A	---	.168	A	.172	.180
B	.135	.155	B	.180	.220
C	.047	.052	C	.020	.028
D	1.00	---	D	.002	---
AXIAL 			* Dimensions prior to solder finish		
			SMS 		

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